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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takayuki Ikeda	11/04/2021
Hitoshi Kunitake	11/05/2021

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398. HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17616539

CORRESPONDENCE DATA

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: apsi@fr.com

Correspondent Name: JOHN F. HAYDEN

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ATTORNEY DOCKET NUMBER: 12732-2172US1 NAME OF SUBMITTER: **APRIL SAUNDERS-FULLER** SIGNATURE: /April Saunders-Fuller/ **DATE SIGNED:** 12/03/2021

Total Attachments: 1

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PATENT REEL: 058285 FRAME: 0576 507008959

<u>ASSIGNMENT</u>

For valuable consideration, We, <u>Takayuki IKEDA of Atsugi</u>, <u>Kanagawa</u>, <u>Japan and Hitoshi KUNITAKE of Isehara</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese corporation having a place of business at:</u>

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled COMMUNICATION DEVICE AND ELECTRONIC DEVICE, filed December 3, 2021, and assigned U.S. Serial Number 17/616,539 we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignce may reasonably request to effectuate fully this assignment.

Signature	Takayuki Ikeda
Name:	Takayuki IKEDA
Date:	11/04/2021
Signature	Hitoshi KUNJIAKE
Name:	Hitoshi KUNITAKE
Date:	11/05 /2021

RECORDED: 12/03/2021

PATENT REEL: 058285 FRAME: 0577